PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
LI QIAN	06/30/2022

RECEIVING PARTY DATA

Name:	HP Printing and Computing Solutions, S.L.U.	
Street Address:	Calle Jose Echegaray, 18, Parque Empresarial	
City:	Las Rozas-Madrid	
State/Country:	SPAIN	
Postal Code:	28232	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	17419085	

CORRESPONDENCE DATA

Fax Number: (970)778-4063

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Email: admin@jordaniplaw.com, ebeasterfield@jordaniplaw.com

Correspondent Name: HP INC.

Address Line 1: 3390 E. HARMONY ROAD MS 35
Address Line 4: FORT COLLINS, COLORADO 80528

ATTORNEY DOCKET NUMBER:	86039000	
NAME OF SUBMITTER:	DIALLO T. CRENSHAW	
SIGNATURE:	/ Diallo T. Crenshaw /	
DATE SIGNED:	06/26/2023	

Total Attachments: 1

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PATENT 507978040 REEL: 064105 FRAME: 0394

HP Inc. 3390 E. Harmony Road Mail Stop 35 Fort Collins, Colorado 80528

RECORD	ID:	86039000
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ASSIGNMENT OF PATENT APPLICATION

I, the undersigned, to the extent not already owned by or assigned and transferred to HP Printing and Computing Solutions, S.L.U., according to applicable law by virtue of my employment or agreement related thereto, for good and valuable consideration, the receipt of which is hereby acknowledged, agree to assign and transfer and hereby assign and transfer to

transfer to					
HP Printing and Computing Solutions, S.L.U (hereinafter "HP PCS"),	l., a Spanish company	having it	ts principal p	lace of busine	ess in Madrid, SPAIN,
its successors, and its assigns, my entire rig application for patent entitled (English-languag	ht, title, and interest, ir e title in parentheses if	cluding said ap	all rights of p plication for p	riority, in, to, patent is in an	and under an nother language):
Title: COMPENSATING OVER-SATURATIO	N DUE TO DYE-ENRIC	CHED C	OLORANT	***************************************	·····
Filing Date: 21 Feb 2019	Application No.: 17	/419085	i		Patent Office: US;
the subject matter, including any and all inve (as used herein "patent" refers to any form of ir utility patent rights, design rights, and utility mo applications for patent of any country or region without limitation, said application for patent, are benefit of any application for patent for any of so for patent for any of said Inventions directly or it continuation-in-part applications (hereinafter "Cophase applications of, renewals of, and substitus "Applications for Patent"); any and all patents we (hereinafter "Patents"); and any and all reissues Patents.	ntellectual property prodel rights) (hereinafter or under any internations and all applications aid Inventions, any and indirectly claims priority (IPs") of, divisional apputes for any application which may be granted or	tection in it is in a great for pater or beneat it is in a great i	ncluding, with ons"); any an ement for ar it directly or i lications for p efit, and any a of, national- ent for any of a result of sa	nout limitation Id all existing Iny of said Inve- Indirectly clair Interest from we Interes	, invention rights, and future entions (including, ming priority to or hich any application unation applications of, ations of, regionalms) (hereinafter is for Patent
I HEREBY represent that I convey my full rig entire right, title, and interest herein assigned a agreement in conflict herewith;	hts in all countries and nd transferred, and tha	regions t I have	and under a not executed	ll internationa I and will not	al agreements to the execute any
AND I HEREBY authorize HP PCS, its succe Applications for Patent in its name or in my nan authorize HP PCS, its successors, its assigns, in number, and patent office of said application for to them;	ne in any country or reg its nominees, and its le	jion or u gal repre	nder any inte esentatives to	ernational agre o insert the fil	eement, and further ling date, application
AND I HEREBY authorize and request the of whose duty it is to issue patents, to issue to HP interest, said Patents, in accordance with the te	PCS, its successors, of	or its ass	igns, as assi	r all internation gnee of my e	onal agreements entire right, title, and
AND t HEREBY covenant and agree that I will such papers as may be necessary or desirable to HP PCS, its successors, or its assigns; common representatives, all known facts respecting said administrative proceedings and sign all lawful pupplications, CIPs, and reissue applications) relightful oaths and declarations and generally to nominees, and its legal representatives to obtain property protection for said Inventions, Applications in lending such cooperation and assistance representatives.	ole to perfect the title in nunicate to HP PCS, its Inventions, Application apers (including, withou ating to said Inventions do everything possible n, maintain, and enforce ons for Patent, and Pa	said Inv s succes as for Pa ut limitat s, Applica to aid H e, for its tents, pr	rentions, App sors, its assi tent, and Par ion, divisiona ations for Pa P PCS, its si or their own ovided the e;	lications for F gns, its nominatents; testify in all applications tent, and Pate successors, its benefit, propenses whice	Patent, and Patents, nees, or its legal nany legal or c, continuation ents; and make all assigns, its er intellectual the may be incurred by
IN WITNESS WHEREOF, I hereunto set my I	nand and seal:				
- In		30	June	2022	
Inventor's Signature		Day	Month	2022 Year	
Li QIAN					
Inventor's Legal Name					

Rev 8/2020

PATENT REEL: 064105 FRAME: 0395